### 502512510 09/27/2013

### PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

### **CONVEYING PARTY DATA**

Name	Execution Date	
Jung-Ping YANG	09/12/2013	
Chih-Chieh CHIU	09/12/2013	
Fu-An WU	09/12/2013	
Chia-En HUANG	09/12/2013	
I-Han HUANG	09/12/2013	

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD.
Street Address:	No. 8, Li-Hsin Rd. VI, Hsinchu Science Park
City:	Hsinchu
State/Country:	TAIWAN
Postal Code:	300

## PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14039340

### **CORRESPONDENCE DATA**

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NAME OF SUBMITTER:	Randy A. Noranbrock
	PATENT

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Signature:	/Randy A. Noranbrock/
Date:	09/27/2013
Total Attachments: 1 source=EfiledAssgn#page1.tif	

PATENT REEL: 031298 FRAME: 0446

Docket No. T5057-933 TSMC2013-0829

### ASSIGNMENT

In consideration of the premises and other good and	valuable consideration	in hand	naid, the	receipt	and suffici	iency o
which is hereby acknowledged, the undersigned,			,,		~~~~	

- 1) Jung-Ping YANG
- 4) Chia-En HUANG
- 2) Chih-Chieh CHIU
- 5) I-Han HUANG

3) Fu-An WU

who has made a certain new and useful invention, hereby sells, assigns and transfers unto TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., having a place of business at No. 8, Li-Hain Rd. VI, Helacha Science Pack, Hainelau 300, Taiwan R.O.C.

its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled

# CIRCUIT TO GENERATE A SENSE AMPLIFIER ENABLE SIGNAL

- (a) for which an application for United States Letters Patent was filed on \_\_\_\_\_\_\_; or \_\_\_\_\_\_; or
- (b) for which an application for United States Letters Patent was executed on

and the undersigned hereby authorizes and requests the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefore and any and all extensions, divisions, reissues, continuations, or continuations-in-part thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agrees that the attorneys of record in said application shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agrees to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remaneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE; its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the date indicated aside my signature:

1) Jung - Ping Youry
Name: Jung-Ping YANG

2) Chih - Chieh Chiu
Name: Chih-Chieh CHBU

3) Fu - An Wu
Name: Fu-An Wu
Name: Fu-An Wu
Name: Chia-En Huang

A) Chia - In Huang

Date:

4) Chia - In Huang

Date:

7/12/2

Date:

Date: 9/12/2013

Date: 9/12/2013

Date: 9/12/2013

PATENT REEL: 031298 FRAME: 0447

**RECORDED: 09/27/2013**